

## Platamid® H 2513 Pellets

Copolyamide Hot Melt Adhesive

**Platamid® H 2513** is a standard thermoplastic copolyamide hot melt adhesive available in pellet form. This low to medium melt viscosity, fast re-crystallizing grade is particularly suitable for manufacturing webs, nets, mono- and multi-filaments, and films by extrusion.

**Platamid® H 2513** offers a very good adhesion to various polar substrates (thermoplastics, thermosets, metal, natural fibers, etc).

PROPERTIES	DRY / COND	UNIT	TEST STANDARD
RHEOLOGICAL PROPERTIES			
Melt Volume-Flow Rate	26 / *	cm <sup>3</sup> /10 min	ISO 1133
Temperature	160 / *	°C	-
	320 / *	°F	-
Load	2.16 / *	kg	-
	4.76 / *	lb	-
THERMAL PROPERTIES			
Melting Temperature, 10°C/min	128 / *	°C	ISO 11357-1/-3
OTHER PROPERTIES			
Density	1070 / -	kg/m <sup>3</sup>	ISO 1183
	1.07 / -	g/cm <sup>3</sup>	

## AVAILABLE GRADES

This grade is available dried with optical brightener (Platamid® H 2513 TA)

## PACKAGING

Platamid® H 2513 is delivered in 25 kg sealed bags and 500 kg sealed big bags (GRVS).

## SHELF LIFE

Two years from the date of delivery. For any use above this limit, please refer to our technical services.

<b>DELIVERY FORM</b>  Pellets	Headquarters:  Arkema France 420 rue d'Estienne d'Orves 92705 Colombes Cedex France T +33 (0)1 49 00 80 80 hpp.arkema.com
<b>SPECIAL CHARACTERISTICS</b>  Adhesive	
<b>REGIONAL AVAILABILITY</b>  North America, Europe, Asia Pacific, South and Central America, Near East/Africa	

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